

2024 ASME EPPD Awards — Call for Nominations

Deadline: July 21, 2024, 5:00 PM PST

ASME's Electronic and Photonic Packaging Division (EPPD) is soliciting nominations for the following annual division awards:

1. EPPD Excellence in Mechanics Award
2. EPPD Women Engineer Award
3. EPPD Early Career Engineer Award
4. EPPD Student Member of the Year Award

Complete nominations should be submitted by email to both Dr. Koneru Ramakrishna (rama@ieee.org) and Dr. Yogendra Joshi (yogendra.joshi@me.gatech.edu), Co-Chairs of the 2024 EPPD Awards Committee, and are **due by July 21, 2024, 5:00 PM Pacific Time**. Please include the words "Nomination for EPPD Award: Category" in the subject line of your email. The following items are required in each nomination packet:

- I. Nomination letter summarizing Nominee's qualifications and accomplishments.
- II. Nominee's CV/Bio (50 pages or less).
- III. Up to 3 letters of support.
- IV. Nominee's current ASME membership status, ASME member number, and the primary Division(s) the nominee is associated with.

The nominations will be evaluated by the EPPD Awards Committee, which consists of past senior members of EPPD and some of the past winners. The awards will be announced prior to the 2024 ASME InterPACK and will be presented during the Conference.

Details of the Awards follow:

1. Excellence in Mechanics Award

- a. The award is to recognize outstanding contributions to engineering mechanics applications in electronic and/or photonic packaging, including stress analysis, reliability study, experimental methods, and computational modeling.
- b. Emphasis will be placed on seminal work and product innovation and product development demonstrated through technical publications and patents.

2. EPPD Women Engineer Award

- a. The award is to recognize a woman engineer with significant technical achievements in electronic and photonic packaging demonstrated through papers, patents, or product development.
- b. Contributions to EPPD activities (conferences, committees, Journal of Electronic Packaging, and K16) are also important considerations.
- c. Nominee must be a primary or a secondary member of EPPD for at least last 1 year prior to nomination or has demonstrated active involvement and outstanding contributions to InterPACK conference for the past 3 consecutive years.

3. EPPD Early Career Engineer Award

- a. The award is to recognize a young engineer with significant technical achievements in the career in electronic and photonic packaging demonstrated through papers, patents, or product development.
- b. Contributions to EPPD activities (conferences, committees, Journal of Electronic Packaging, and K16) are very important.
- c. Nominee must be a primary or a secondary member of EPPD for at least last 1 year prior to nomination or has demonstrated active involvement and outstanding contributions to InterPACK conference for the past 3 consecutive years.
- d. Nominee must be within 10 years since the last degree received before December 31, 2024 (the year of the award).

4. EPPD Student Member of the Year Award

- a. Nominee must be enrolled as a full-time undergraduate or graduate student (or must have graduated no earlier than July 1, 2024), conducting research in electronic and photonic packaging.
- b. The award is to recognize a current student, who has excelled in research and has demonstrated strong contributions to the field of electronic and photonic packaging.
- c. Must demonstrate active participation in conferences such as EPPD's InterPACK, IMECE, ITherm and similar conferences.